SCOPE:

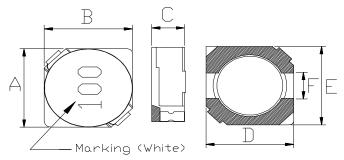
This specification applies to the Pb Free high current type SMD inductors for MSCDRI-6D38-SERIES

PRODUCT INDENTIFICATION

MSCDRI - 6D38 - 100 M

- 1
- 2
- 3 4
- **1** Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 6.70±0.3 mm
B: 6.70±0.3 mm
C: 4.00 Max. mm
D: 6.50 Typ. mm
E: 6.50 Typ. mm
F: 2.00 Typ. mm

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Ambient temperature +60°C Max.

(3)-2 Operate temperature range -40° C $\sim +125^{\circ}$ C (Including self temp. rise)

(3)-3 Storage temperature range -40° C $\sim +125^{\circ}$ C

TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current	
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω) Max.	IDC(A)	Marking
MSCDRI-6D38-1R0	1.0	N	100kHz/0.25V	10m	4.50	1R0
MSCDRI-6D38-1R5	1.5	N	100kHz/0.25V	11m	4.30	1R5
MSCDRI-6D38-2R2	2.2	N	100kHz/0.25V	15m	4.00	2R2
MSCDRI-6D38-3R3	3.3	M,N	100kHz/0.25V	20m	3.50	3R3
MSCDRI-6D38-3R8	3.8	N	100kHz/0.25V	20m	3.50	3R8
MSCDRI-6D38-5R0□	5.0	N	100kHz/0.25V	24m	2.90	5R0
MSCDRI-6D38-6R2□	6.2	N	100kHz/0.25V	27m	2.50	6R2
MSCDRI-6D38-6R8□	6.8	M,N	100kHz/0.25V	29m	2.40	6R8
MSCDRI-6D38-7R4□	7.4	N	100kHz/0.25V	31m	2.30	7R4
MSCDRI-6D38-8R2□	8.2	N	100kHz/0.25V	34m	2.20	8R2
MSCDRI-6D38-8R7□	8.7	N	100kHz/0.25V	34m	2.20	8R7
MSCDRI-6D38-100□	10	M,N	100kHz/0.25V	38m	2.00	100
MSCDRI-6D38-120□	12	M,N	100kHz/0.25V	53m	1.70	120
MSCDRI-6D38-150□	15	M,N	100kHz/0.25V	57m	1.60	150
MSCDRI-6D38-180□	18	M,N	100kHz/0.25V	92m	1.50	180
MSCDRI-6D38-220□	22	M,N	100kHz/0.25V	96m	1.30	220
MSCDRI-6D38-270□	27	M,N	100kHz/0.25V	0.109	1.20	270
MSCDRI-6D38-330□	33	M,N	100kHz/0.25V	0.124	1.10	330
MSCDRI-6D38-390□	39	M,N	100kHz/0.25V	0.138	1.00	390
MSCDRI-6D38-470□	47	M,N	100kHz/0.25V	0.155	0.95	470
MSCDRI-6D38-560□	56	M,N	100kHz/0.25V	0.202	0.85	560
MSCDRI-6D38-680□	68	M,N	100kHz/0.25V	0.234	0.75	680
MSCDRI-6D38-820□	82	M,N	100kHz/0.25V	0.324	0.70	820
MSCDRI-6D38-101□	100	K,M,N	100kHz/0.25V	0.358	0.65	101
MSCDRI-6D38-331□	330	M,N	100kHz/0.25V	1.550	0.35	331

[※] ☐ specify the inductance tolerance,K(±10%),M(±20%),N(±30%)

%IDC : Based on inductance change (\triangle L/Lo : \leq drop 35%) @ambient temperature 25°C and Based on temperature rise (\triangle T : 40°C TYP.)



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damege.	Ţ			
		R5 45±2 45±2 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130 \sim 150 $^{\circ}$ C and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			



MECHANICAL

TEST ITEM	SPECIFICATION					
TEST ITEM Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature profile of reflow soldering soldering (Peak temperature 260±3° 10 sec Pre-heating 150 Pre-heating Slow cooling (Stored at room temperature) The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions				
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than 1 × 10^8 Ω .
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20℃ ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM	TOTAKAOTE	SPECIFICATION					
High temperature	∆L/Lo≦±5%						
storage	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		·				
Storage	There shall be	·	a temperature of 85±2°C and a normal humidity.				
			Upon completion of the measurement shall be made after the sample has been left in a normal temperature and normal				
	no mechanical	-	•	erature and normal			
	damage.	humidity for	humidity for 1 hour.				
		-					
Low temperature	∆L/Lo≦±5%		shall be left for 96±4 hours	s in an atmospnere with			
storage		-	re of -25±3℃.				
	There shall be		etion of the test, the meas				
	no mechanical	after the san	nple has been left in a nor	mal temperature and			
	damage.	normal humi	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sample s	The sample shall be subject to 5 continuos cycles, such as shown				
temperature		in the table 2	below and then it shall be	e subjected to standard			
	There shall be	atmospheric	conditions for 1 hour, aft	er which measurement			
	no other dama-	shall be mad	e.				
	ge of problems						
1			table 2				
1			Temperature	Duration			
		1	−25±3 °C	30 min.			
1			(Themostat No.1)	30 mm.			
1		2	Standard				
1			atmospheric	No.1→No.2			
			85±2℃	20 :			
		3	(Themostat No.2)	30 min.			
			Standard				
		4	atmospheric	No.2→No.1			
Moisture storage	∆L/Lo≦±5%	The sample s	shall be left for 96±4 hours	s in a temperature of			
1		40±2℃ and a humidity(RH) of 90∼95%.					
1	There shall be	Upon comple	Upon completion of the test, the measurement shall be made				
1	no mechanical	after the sample has been left in a normal temperature and normal humidity more than 1 hour.					
l	damage.						
Test conditions :							
The s	The sample shall be reflow soldered onto the printed circuit board in every test.						

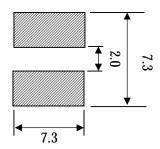


(5) LAND DIMENSION (Ref.)

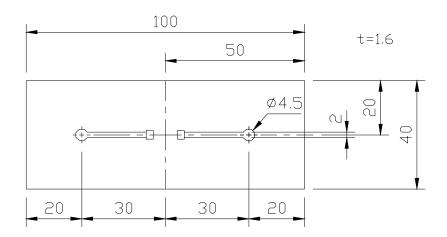
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit: mm



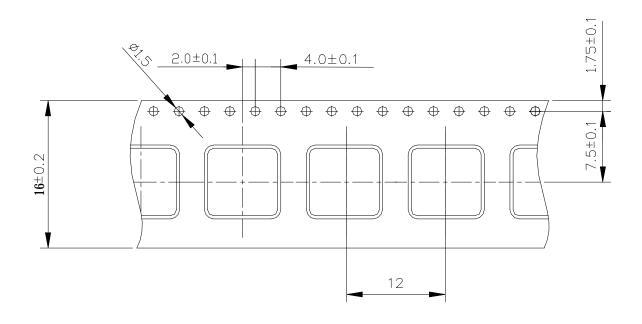
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



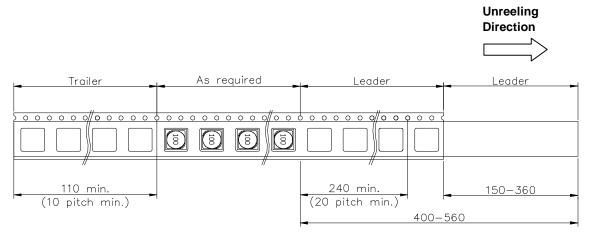


(6) PACKAGING

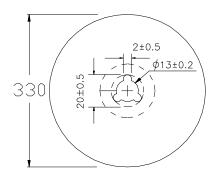
(6)-1 CARRIER TAPE DIMENSIONS (mm)

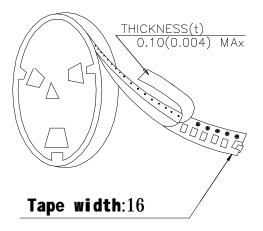


(6)-2 TAPING DIMENSIONS (mm)



(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.

